

RX Family

JPEG Encoder Module

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Firmware Integration Technology

Introduction

This material explains usage of JPEG Encoder (JPEGE).

JPEG Encoder is only for encoding, and there are the following two libraries.

JPEG Encode Library: DCT, Quantization and Huffman encoding.

JPEG File Compress Library: Compress JPEG data using JPEG Encode Library.

Normally, the API for the JPEG File Compress Library is used to compress bitmap images into the JPEG image format. But since the source code for the JPEG File Compress Library is provided, users can also change the specifications to match the particular needs of their applications.

JPEGE is provided as Firmware Integration Technology (FIT) Module. Please refer to the URL to know FIT outline. http://www.renesas.com/products/mpumcu/rx/child/fit.jsp

Target Device

RX Family

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1. Structure of product

Package name : JPEG Encoder for the RX Family V.1.01 Release 00

Table 1.1 Product Files of JPEG Encoder

File/Directory name	description	
JPEGE FIT Module (r_jpege_rx_v.1.01.zip)		
JPEGE config (r_config)		
r_jpege_rx_config.h	JPEGE Config file (default setting)	
JPEGE FIT Module body (r_jpege_rx)		
JPEGE document (doc)		
Japanese (ja)		
r20an0263jj0101_rx_jpege.pdf	Introduction Guide	
r20uw0122jj0100_jpege.pdf	User's Manual	
English (en)		
r20an0263ej0101_rx_jpege.pdf	Introduction Guide (this document)	
r20uw0122ej0100_jpege.pdf	User's Manual	
JPEGE Library (lib)		
jpege_rx600_little.lib		
jpege_rx600_big.lib		
jpege_rx200_little.lib	JPEG Encode Library and header file	
jpege_rx200_big.lib		
r_jpeg.h		
compress_jpege_rx600_little.lib		
compress_jpege_rx600_big.lib	IDEC File Compress Library and booder file	
compress_jpege_rx200_little.lib compress_jpege_rx200_big.lib	JPEG File Compress Library and header file	
r_compress_jpege.h		
r stdint.h	Data type header file	
r mw version.h	Version data header file	
JPEG File Compress Library make enviror		
	JPEG File Compress Library make environment	
make_lib.zip	(includes source code)	
JPEGE config reference (ref)		
r_jpege_rx_config_reference.h	JPEGE config file (template)	
readme(readme.txt)	Readme	

Specification of library

2.1 Structure of software stack

This figure explains structure of software stack of JPEG Encoder.

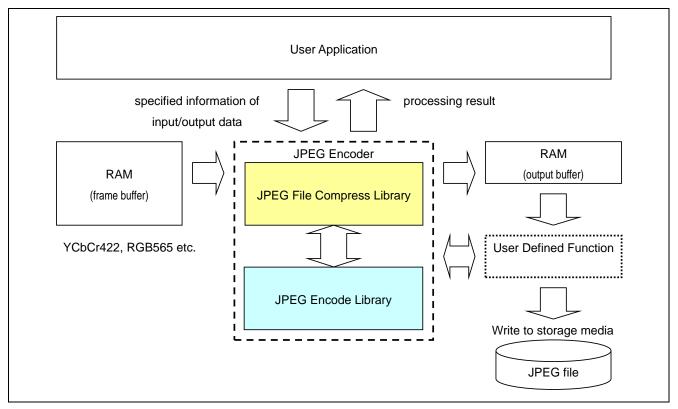


Figure 2.1 Structure of Software Stack

2.2 **Specification of JPEG File Compress Library**

Specification of this JPEG File Compress Library is below.

Table 2.1 specification of JPEG Compress Library

Items		Specifications	
Output	Support format	JFIF	
JPEG File	Elements of color	3 colors (YCbCr)	
	Ratio of sample	4:2:2 (2x1,1x1,1x1) or 4:2:0 (2x2,1x1,1x1)	
	Image quality	A value in the range 1 to 128 may be specified.	
	Restart marker	Either none or an arbitrary interval may be set.	
	Comment	none	
	Exif	No support	
	Progressive	No support	
	Thumbnail	No support	
	Output units	Output buffers with an arbitrary size may be provided and the data can be stored to various media in units of that size.	
Input	Image format	RGB565 (16bit color), RGB888 (24bit color), YCbCr 4:2:2	
Image data	Input units	Data is read as single unit. (Reading divided into smaller units is not possible.)	

The source code of JPEG File Compress Library is attached so that a user can change specification.

2.3 Development environment

JPEG Encoder can run with this development environment below.

```
[IDE]  CS+V3.03.00 \\ e^2 studio\ V4.2.0.012 \\ [C\ compiler] \\ C/C++\ Compiler\ Package\ for\ RX\ Family\ V.1.02\ Release\ 01 \\
```

Library file is built with default compile option.

- compile option (RX200 little endian)
 cpu=rx200 -output=obj="\$(CONFIGDIR)\\$(FILELEAF).obj" -nologo
 compile option (RX200 big endian)
 Adding "-endian=big" to default option.

2.4 Specification of API

Specification of JPEG Compress Library APIs are below.

Table 2.2 API (JPEG File Compress Library)

function name	outline
R_compress_jpeg	compress bitmap images into JPEG files

Note: Refer to the JPEG Encoder User's Manual to know details.

Specification of JPEG Encode Library APIs are below.

Table 2.3 API (JPEG Encode Library)

function name	outline
R_jpeg_add_quant_table	Registers Quantization table
R_jpeg_DCT	Executes DCT and quantization
R_jpeg_encode_one_block	Executes Huffman encoding
R_jpeg_writeDRI	Writes DRI
R_jpeg_writeRST	Writes RSTm
R_jpeg_writeEOI	Writes EOI
R_jpeg_flush_bits	Forcibly writes Huffman encoded data

Note: Refer to the JPEG Encoder User's Manual to know details.

2.5 ROM size / RAM size / Stack size

JPEG Encoder requires ROM/RAM/Stack size as below.

Table 2.4 ROM/RAM size (JPEG File Compress Library)

kind	section name	Attribute,	size [byte]		
		Alignment	RX600, RX200	RX600, RX200	
			little endian	big endian	
ROM	P_jpeg_cmp_F (*)	code	3005	2990	
	P_jpeg_cmp_S	code	2980	2980	
	C_jpeg_cmp_F (*)	data, align=4	16	16	
	C_jpeg_cmp_F_2 (*)	data, align=2	256	256	
	C_jpeg_cmp_S	data, align=4	388	388	
Total	-	-	6645	6630	
RAM	B_jpeg_cmp_F (*)	data, align=4	1164	1164	
	B_jpeg_cmp_F_2 (*)	data, align=2	128	128	
	B_jpeg_cmp_F_1 (*)	data, align=1	384	384	
Total	-	-	1676	1676	

Note: (*): Recommends arranging to a high speed memory.

Table 2.5 ROM/RAM size (JPEG Encode Library)

Kind	section name	Attribute, Alignment	size [byte]	
			RX600, RX200	RX600, RX200
			little endian	big endian
ROM	P_jpeg_enc_F (*)	code	1050	1050
	P_jpeg_enc_F_8 (*)	code, align=8	644	644
	P_jpeg_enc_S	code	203	204
	C_jpeg_enc_F (*)	data, align=4	2536	2536
	C_jpeg_enc_F_1 (*)	data, align=1	64	64
	C_jpeg_enc_S	data, align=4	828	828
Total	-	-	5325	5326
RAM	-	-	0	0
Total	-	-	0	0

Note: (*): Recommends arranging to a high speed memory.

Table 2.6 Stack size (JPEG File Compress Library)

API function name	stack size [byte]	
	RX600, RX200 RX600, RX200	
	little endian	big endian
R_compress_jpeg	296	296

Table 2.7 Stack size (JPEG Encode Library)

API function name	stack size [byte]		
	RX600, RX200	RX600, RX200	
	little endian	big endian	
R_jpeg_add_quant_table	36	36	
R_jpeg_DCT	4	4	
R_jpeg_encode_one_block	60	60	
R_jpeg_writeDRI	12	12	
R_jpeg_writeRST	36	36	
R_jpeg_writeEOI	8	8	
R_jpeg_flush_bits	24	24	

2.6 Version information

Version information is stored in this library. Version information can be accessed if the header of this library is included. The data stored in this library is as follows.

2.6.1 RX600 (little endian)

```
JPEG File Compress Library (compress_jpege_rx600_little.lib)

#include "r_compress_jpegd.h"

Version infomation of a Library
R_compress_jpege_version.library[] =
    "JPEG File Compress Library version 1.00 for the RX600 LITTLE endian.(Sep 12 2013, 11:40:46)"

Version infomation of a compiler
R_expand_jpegd_version.complier = 0x01020100

JPEG Encode Library (jpege_rx600_little.lib)

#include "r_jpeg.h"

Version infomation of a Library
R_jpege_version.library[] =
    "JPEG Encode Library version 1.01 for the RX600 LITTLE endian.(Feb 18 2016, 21:07:57)"
```

2.6.2 RX600 (big endian)

Version infomation of a compiler

 $R_{ipegd_version.complier} = 0x01020100$

```
JPEG File Compress Library (compress_jpege_rx600_big.lib)

#include "r_compress_jpege.h"

Version infomation of a Library
R_compress_jpege_version.library[] =
    "JPEG File Compress Library version 1.00 for the RX600 BIG endian.(Sep 12 2013, 11:40:42)"

Version infomation of a compiler
R_expand_jpegd_version.complier = 0x01020100

JPEG Encode Library (jpege_rx600_big.lib)

#include "r_jpeg.h"

Version infomation of a Library
R_jpege_version.library[] =
    "JPEG Encode Library version 1.01 for the RX600 BIG endian.(Feb 18 2016, 21:08:09)"

Version infomation of a compiler
R jpegd version.complier = 0x01020100
```

2.6.3 RX200 (little endian)

```
JPEG File Compress Library (compress_jpege_rx200_little.lib)
  #include "r_compress_jpege.h"
  Version infomation of a Library
    R_compress_jpege_version.library[] =
      "JPEG File Compress Library version 1.00 for the RX200 LITTLE endian. (Sep 12 2013, 11:40:37)"
  Version infomation of a compiler
    R_expand_jpegd_version.complier = 0x01020100
JPEG Encode Library (jpege_rx200_little.lib)
  #include "r_jpeg.h"
  Version infomation of a Library
    R_jpege_version.library[] =
      "JPEG Encode Library version 1.01 for the RX200 LITTLE endian.(Feb 18 2016, 21:08:15)"
  Version infomation of a compiler
    R_{jpegd\_version.complier} = 0x01020100
2.6.4
            RX200 (big endian)
JPEG File Compress Library (compress_jpege_rx200_big.lib)
  #include "r_compress_jpege.h"
  Version infomation of a Library
    R_compress_jpege_version.library[] =
      "JPEG File Compress Library version 1.00 for the RX200 BIG endian. (Sep 12 2013, 11:40:33)"
  Version infomation of a compiler
    R_expand_jpegd_version.complier = 0x01020100
JPEG Encode Library (jpege_rx200_big.lib)
  #include "r_jpeg.h"
  Version infomation of a Library
    R_jpege_version.library[] =
      "JPEG Encode Library version 1.01 for the RX200 BIG endian.(Feb 18 2016, 21:08:22)"
  Version infomation of a compiler
    R_{jpegd\_version.complier} = 0x01020100
```

3. Usage of Libraries

3.1 Usage of JPEG File Compress library

Please link the library file to user application.

RX600 little endian: jpege_rx600_little.lib, compress_jpege_rx600_little.lib RX600 big endian: jpege_rx600_big.lib, compress_jpege_rx600_big.lib RX200 little endian: jpege_rx200_little.lib, compress_jpege_rx200_little.lib RX200 big endian: jpege_rx200_big.lib, compress_jpege_rx200_big.lib

Please include the header files with library.

#include "r_compress_jpege.h"

3.2 Usage of JPEG Encode Library

Please link the library file to user application.

RX600 little endian: jpege_rx600_little.lib RX600 big endian: jpege_rx600_big.lib RX200 little endian: jpege_rx200_little.lib RX200 big endian: jpege_rx200_big.lib

Please include the header files with library.

#include "r_jpeg.h"

4. Adding Library to Your Project

The lib folder has all Libraries for RX Family. Add the required library for your project.

4.1 Adding Library to CS+ Project

Please refer to the Adding Firmware Integration Technology Modules to Projects.

• Adding Firmware Integration Technology Modules to CS+ Projects (R01AN1826)

Adding Library

- (1) Adding FIT modules to projects.
- (2) Open: Project Tree >> File >> [FIT Module name] >> lib.
- (3) All Libraries will be linked for building. Please remove the Libraries excluding your needing libraries. Right click on the removed library file name, select "Remove from Project".

4.2 Adding Library to e² studio Project

Please refer to the Adding Firmware Integration Technology Modules to Projects.

• Adding Firmware Integration Technology Modules to Projects (R01AN1723)

Adding Library

- (1) Adding FIT modules to projects.
- (2) Right click on the project name in the Project Explorer, then choose "Properties" from the pop-up menu.
- (3) The "Properties" dialog is shown. The right side of this dialog changes as you select categories on the left. Select the following in order:

```
"C/C++ Build" >> "Settings" >> "Linker" >> "Input" Click the "Add..." button.
```

(4) Adding library.

5. Notes

- This library uses DSP instructions. Please push/pop accumulator register (ACC) in user interrupts function using accumulator, because DSP instructions uses accumulator (RX600).
- This library can be used with Microcontroller Options fint_register=0 (Fast interrupt vectorregister [None]). The default for this option is fint_register=0.
- This library is using Application Notes "Color Space Conversion Using the DSP Instructions" [R01AN0225EJ0100]. Refer to it to know details.

6. Software Update Information

Package version	Date	Description
V.1.00 Release 00	Mar 17, 2015	First release
V.1.01 Release 00	Apr 01, 2016	Updated version number with the xml file revision.

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Revision History

Description

Rev.	Date	Page	Summary
1.00	Mar.17.15	_	First edition issued
1.01	Apr.01.16	_	Update the xml file for FIT

General Precautions in the Handling of Microprocessing Unit and Microcontroller Unit Products

The following usage notes are applicable to all Microprocessing unit and Microcontroller unit products from Renesas. For detailed usage notes on the products covered by this document, refer to the relevant sections of the document as well as any technical updates that have been issued for the products.

1. Handling of Unused Pins

Handle unused pins in accordance with the directions given under Handling of Unused Pins in the manual.

The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible. Unused pins should be handled as described under Handling of Unused Pins in the manual.

2. Processing at Power-on

The state of the product is undefined at the moment when power is supplied.

- The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the moment when power is supplied.
 - In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the moment when power is supplied until the reset process is completed.

In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the moment when power is supplied until the power reaches the level at which resetting has been specified.

3. Prohibition of Access to Reserved Addresses

Access to reserved addresses is prohibited.

 The reserved addresses are provided for the possible future expansion of functions. Do not access these addresses; the correct operation of LSI is not guaranteed if they are accessed.

4. Clock Signals

After applying a reset, only release the reset line after the operating clock signal has become stable. When switching the clock signal during program execution, wait until the target clock signal has stabilized.

When the clock signal is generated with an external resonator (or from an external oscillator) during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Moreover, when switching to a clock signal produced with an external resonator (or by an external oscillator) while program execution is in progress, wait until the target clock signal is stable.

5. Differences between Products

Before changing from one product to another, i.e. to a product with a different part number, confirm that the change will not lead to problems.

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